

2.4GHz 3216 Chip Antenna: RANT3216F245C03



Application:

WLAN, 802.11b/g, Bluetooth, WLAN, etc...

Features

SMD, high reliability, ultra Impact, Omni-directional...

Part number Information

RANT 3216 F 245 C 03
(A) (B) (C) (D) (E) (F)

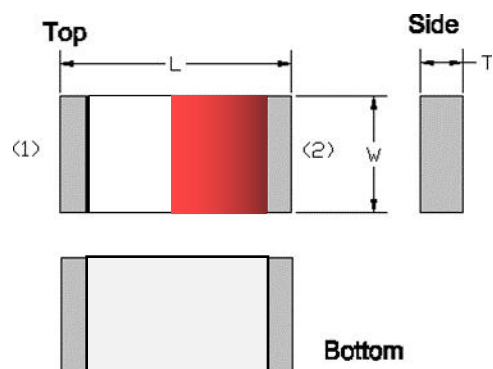
(A)Product Type	Chip Antenna
(B) Size Code	3.2x1.6mm(±0.2mm)
(C) Material	High K material
(D) Frequency	2.4 ~ 2.5GHz
(E) Feeding mode	PIFA & Single Feeding
(F) Antenna type	Type=03

Electrical Specification

Working Frequency Range	2400 ~2500 MHz
Bandwidth	120 MHz (Min.)
Peak Gain	1.20dBi
Impedance	50 Ohm
Return loss	10 dB (Min)
Polarization	Linear
Azimuth Beamwidth	Omni-directional
Operation Temperature(°C)	-40 ~85°C
Resistance to Soldering Heats	10sec. (@ 280°C)
Termination	Ni / Au (Leadless)

The specification is defined on EVB.

Dimension and Terminal Configuration



Dimension (mm)	
L	3.20 ± 0.20
W	1.60 ± 0.20
T	0.45 ± 0.20

No.	Terminal Name
1	Feeding/GNG
2	GND/Feeding

Evaluation Board Reference

长条板PCB 推荐 Dimension	圆板Antenna Layout Reference
	 Unit :mm

Electrical Characteristics

Return Loss & Radiation

Return Loss

Return Loss Plot (S22 Log Mag) showing Return Loss (dB) versus Frequency (GHz). The plot displays a sharp resonance dip at 2.45 GHz, indicating high return loss at this frequency.

Legend:

- >1 2.400000000 GHz -10.502 dB
- 2 2.450000000 GHz -30.620 dB
- 3 2.500000000 GHz -11.472 dB

Plot Settings: S22 Log Mag 10.00dB/ Ref 0.000dB [F1]

Plot Range: Start 1 GHz, Stop 3 GHz, IFBW 70 kHz

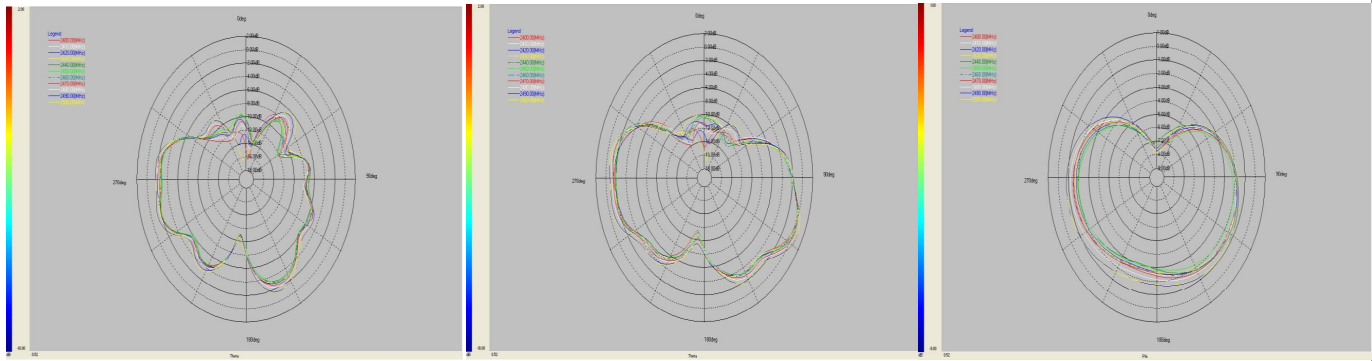
Micrograph of the PCB showing the PIFA antenna structure. Dimensions are indicated by yellow arrows: 1.0mm for the top horizontal segments and 0.5mm for the bottom horizontal segment.

Frequency(MHz)	S11 (dB)
2400	-10.50
2450	-30.62
2500	-11.47

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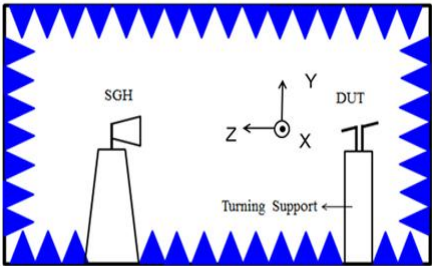
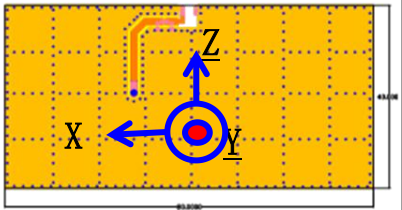


Radiation



Efficiency and Gain (dBi)

Frequency MHz	theta=90		E-total dBi	Efficiency %
	Peak	avg		
2400	1.06	-0.45	0.50	70%
2450	1.20	-0.52	0.36	69%
2500	1.18	-0.72	0.29	72%



Taping Specifications

Reel and Taping Specification

Reel Specification

The diagram shows a 7-inch reel with two views: a front view on the left and a back view on the right. The front view shows a central hub with four spokes and a central mounting point. The back view shows a similar hub with four spokes. Dimensions are indicated: A is the width of the reel, B is the diameter of the central hub, C is the diameter of the outer rim, and D is the thickness of the reel.

7" x 8 mm

TYPE	SIZE		A	B	C	D
3216	7"	5K/Reel	9.0±0.5	60±2	13.5±0.5	178±2

Tapping Specification

The diagram shows a chip antenna on a paper carrier. The main view is a side view of the carrier with dimensions: A is the width of the carrier, B is the width of the chip, P is the pitch of the carrier, W is the width of the carrier, E is the width of the chip, F is the width of the carrier, G is the width of the chip, H is the width of the carrier, T is the thickness of the carrier, ψD is the diameter of the chip, and I is the thickness of the carrier. A detail view on the right shows the carrier with dimensions T and I.

Packaging	Type	A	B	W	E	F	G	H	T	ψD	P
Paper Type	3216	1.90±0.2 0	3.50±0.2 0	8.0±0.2 0	1.75±0.1 0	3.5±0.05	4.0±0.10	2.0±0.05	0.75±0.1 0	1.50±0.1 0	4.0±0.1

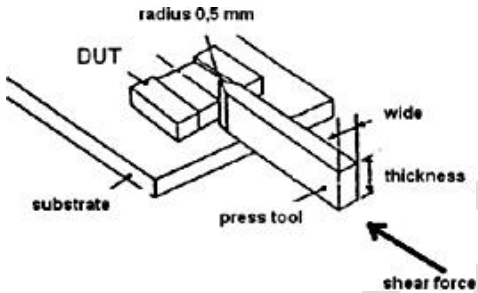
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Reliability Table

Test Item	Procedure	Requirements Ceramic Type	Remark (Reference)
Electrical Characterization		Fulfill the electrical specification	User Spec.
Thermal Shock	1. Preconditioning: $50 \pm 10^{\circ}\text{C}$ / 1 hr , then keep for 24 ± 1 hrs at room temp. 2. Initial measure: Spec: refer Initialspec. 3. Rapid change of temperature test: -30°C to $+85^{\circ}\text{C}$; 100 cycles; 15 minutes at Lower category temperature; 15 minutes at Upper category temperature.	No Visible Damage. Fulfill the electrical specification.	MIL-STD-202 107
Temperature Cycling	1. Initial measure: Spec: refer Initialspec. 2. 100 Cycles (-30°C to $+85^{\circ}\text{C}$), Soak Mode=1 (2 Cycle/hours). 3. Measurement at 24 ± 2 Hours after test condition.	No Visible Damage. Fulfill the electrical specification.	JESD22 JA104
High Temperature Exposure	1. Initial measure: Spec: refer Initialspec. 2. Unpowered; 500hours @ $T=+85^{\circ}\text{C}$. 3. Measurement at 24 ± 2 hours aftertest.	No Visible Damage. Fulfill the electrical specification.	MIL-STD-202 108
Low Temperature Storage	1. Initial measure: Spec: refer Initialspec. 2. Unpowered: 500hours @ $T=-30^{\circ}\text{C}$. 3. Measurement at 24 ± 2 hours aftertest.	No Visible Damage. Fulfill the electrical specification.	MIL-STD-202 108
Solderability (SMD Bottom Side)	Dipping method: a. Temperature: $235 \pm 5^{\circ}\text{C}$ b. Dipping time: $3 \pm 0.5\text{s}$	The solder should cover over 95% of the critical area of bottom side.	IEC 60384-21/22 4.10
Soldering Heat Resistance (RSH)	Preheating temperature: $150 \pm 10^{\circ}\text{C}$. Preheating time: 1~2 min. Solder temperature: $260 \pm 5^{\circ}\text{C}$. Dipping time: $5 \pm 0.5\text{s}$	No Visible Damage.	IEC 60384-21/22 4.10
Vibration	5g's for 20 min., 12 cycles each of 3 orientations Note: Use 8"X5" PCB .031" thick 7 secure points on, one long side and 2 secure points at corners of opposite sides. Parts mounted within 2" from any secure point. Test from 10-2000 Hz.	No Visible Damage.	MIL-STD-202 Method 204
Mechanical Shock	Three shocks in each direction shall be applied along the three mutually perpendicular axes of the test specimen (18 shocks) Peak value: 1,500g's Duration: 0.5ms Velocity change: 15.4 ft/s Waveform: Half-sine	No Visible Damage.	MIL-STD-202 Method 213
Humidity Bias	1. Humidity: 85% R.H., Temperature: $85 \pm 2^{\circ}\text{C}$. 2. Time: 500 ± 24 hours. 3. Measurement at 24 ± 2 hrs after test condition.	No Visible Damage. Fulfill the electrical specification.	MIL-STD-202 Method 106

2.4GHz 3216 Chip Antenna: RANT3216F245C01

Board Flex (SMD)	1. Mounting method: IR-Reflow. PCB Size (L:100 × W:40 × T:1.6mm) 2. Apply the load in direction of the arrow until bending reaches 2 mm.	No Visible Damage.	AEC-Q200 005
Adhesion	Force of 1.8Kg for 60 seconds. 	No Visible Damage Magnification of 20X or greater may be employed for inspection of the mechanical integrity of the device body terminals and body/terminal junction.	AEC-Q200 006
Physical Dimension	Any applicable method using x10 magnification, micrometers, calipers, gauges, contour projectors, or other measuring equipment, capable of determining the actual specimen dimensions.	In accordance with specification.	JESD22 JB100

Revision History

Revision	Date	Content
1	2019/03/01	New Datasheet
2	2020/02/22	Add 2D radiation characteristic